

STP08IE120F4

Emitter Switched Bipolar Transistor ESBT $^{\otimes}$ 1200 V - 8 A - 0.10 Ω

Preliminary Data

General features

V _{CS(ON)}	Ic	R _{CS(ON)}	
0.8 V	8 A	0.10 Ω	

- High voltage / high current Cascode configuration
- Low equivalent on resistance
- very fast-switch up to 150 kHz
- Squared RBSOA up to 1200V
- Very low C_{iss} driven by $R_G = 47\Omega$
- Very low turn-off cross over time

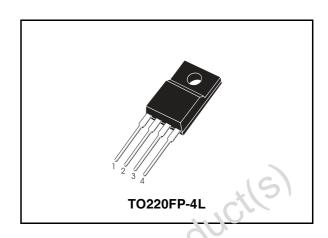
Applications

■ Aux SMPS for three phase mains

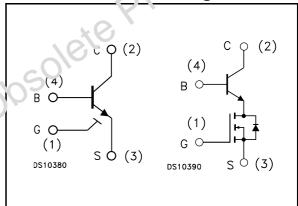
Description

The STP08IE120F4 is manufactured in Monolithic ESBT Technology, aimed to provide best performances in high frequency / high voltage applications.

It is designed for use in Gate Driven kased topologies.



Internal schematic diagrams



Crder codes

Part Number	Marking	Package	Packing
STP08IE120F4	P08IE120F4	TO220FP-4L	Tube

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STP08IE120F4 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum rating

Symbol	Parameter	Value	Unit
V _{CS(SS)}	Collector-source voltage (V _{BS} = V _{GS} = 0 V)	1200	V
V _{BS(OS)}	Base-source voltage (I _C = 0, V _{GS} = 0 V)	30	V
V _{SB(OS)}	Source-base voltage (I _C = 0, V _{GS} = 0 V)	17	V
V _{GS}	Gate-source voltage	土 17	V
I _C	Collector current	8	Α
I _{CM}	Collector peak current (t _P < 5ms)	24	Α
I _B	Base current	6	Α
I _{BM}	Base peak current (t _P < 5ms)	12	А
P _{tot}	Total dissipation at T _c = 25°C	21	W
T _{stg}	Storage temperature	-40 to 150	°C
T_J	Max. operating junction temperature	150	°C

Table 2. Thermal data

	Symbol	Parameter		Value	Unit
	R _{thj-case}	Thermal resistance junction-case	max	6	°C/W
Obsole	P	, roduct(s)			

Electrical characteristics STP08IE120F4

2 Electrical characteristics

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$

Table 3. Electrical characteristics

	Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
	I _{CS(SS)}	Collector-source current (V _{BS} = V _{GS} = 0)	V _{CE} = 1200V			100	μА
	I _{BS(OS)}	Base-source current (I _C = 0, V _{GS} = 0)	V _{BS(OS)} = 30V			10	μА
	I _{SB(OS)}	Source-base current (I _C = 0, V _{GS} = 0)	V _{SB(OS)} = 17V			100	μΑ
	I _{GS(OS)}	Gate-source leakage	V _{GS} = ± 17V			100	nA
	V _{CS(ON)}	Collector-source ON voltage	$V_{GS} = 10V$ $I_{C} = 8A$ $I_{B} = 1.6A$ $V_{GS} = 10V$ $I_{C} = 4A$ $I_{B} = 0.4A$		0.8 0.5	1 1.2	V V
	h _{FE}	DC current gain	$V_{GS} = 10V I_{C} = 8A \qquad V_{CS} = 1V$ $V_{GS} = 10V I_{C} = 4A \qquad V_{CS} = 1V$	5			
	V _{BS(ON)}	Base Source ON voltage	$V_{GS} = 10V I_C = 8A I_B = 1.6A$ $V_{GS} = 10V I_C = 4A I_B = 0.4A$		1.5 1.5		V V
	V _{GS(th)}	Gate threshold voltage	$V_{BS} = V_{GS}$ $I_B = 250 \mu A$	2	3	4	V
	C _{ISS}	Input capacitance	$V_{CS} = 25V$ $f = 1MHz$ $V_{GS} = 0$		550		pF
	Q _{GS(tot)}	Gate-source charge	V _{GS} = 10V		26		nC
	t _s	INDUCTIVE LOAD Storage time Fall time	$\begin{split} &I_C=4A I_B=0.8A \ V_{GS}=10V \\ &V_{Clamp}=960V R_G=47\Omega \\ &t_p=4\mu s \end{split}$		670 15		ns ns
\ (t _s	INDUCTIVE LOAD Storage time Fall time	$I_C = 4A \qquad I_B = 0.4A V_{GS} = 10V$ $V_{Clamp} = 960V R_G = 47\Omega$ $t_p = 4\mu s$		340 10.2		ns ns
Obsoli	V _{CSW}	Maximum collector- source voltage switched without snubber	$R_G = 47\Omega$ $h_{FE} = 5A$ $I_C = 8A$	1200			٧
0.	V _{CS(dyn)}	Collector-source dynamic voltage (500ns)	$V_{CC} = V_{Clamp} = 400V V_{GS} = 10V$ $R_G = 47\Omega I_C = 4A I_B = 0.8A$ $I_{Bpeak} = 4A t_{peak} = 500ns$		5.75		٧
	V _{CS(dyn)}	Collector-source dynamic voltage (1 µs)	$V_{CC} = V_{Clamp} = 400V V_{GS} = 10V$ $R_G = 47\Omega I_C = 4A I_B = 0.8A$ $I_{Bpeak} = 4A t_{peak} = 500ns$		3.35		V

2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. DC current gain

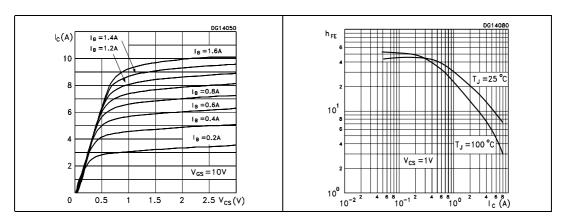


Figure 3. Collector-source On voltage Figure 4. Collector-source On voltage

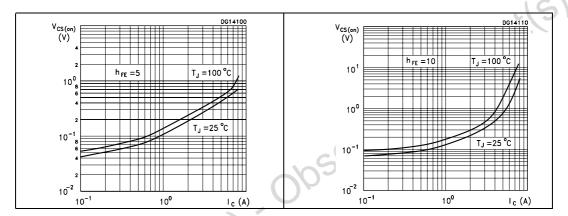
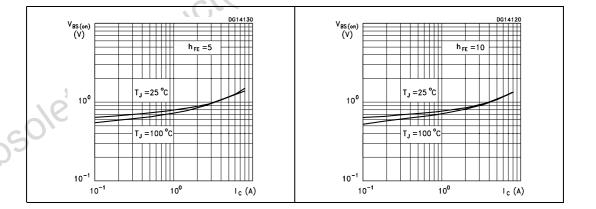


Figure 5. Base-source On voltage

Figure 6. Base-source On voltage



Electrical characteristics STP08IE120F4

Figure 7. Reverse biased safe operting Figure 8. Gate threshold voltage vs area temperature

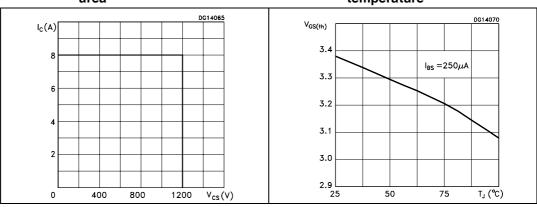


Figure 9. Dynamic collector-emitter saturation voltage

Figure 10. Inductive load switching time

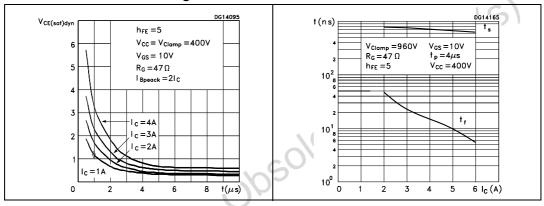
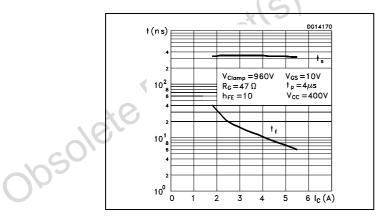
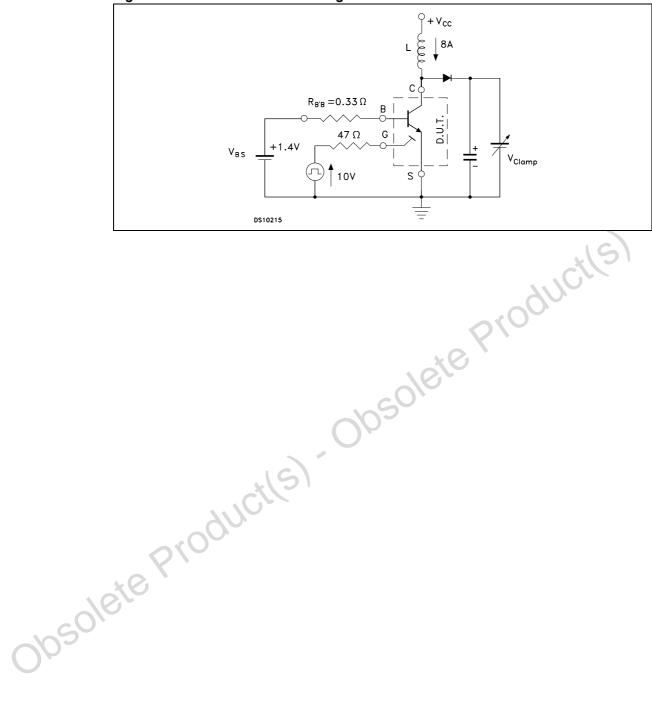


Figure 11. Inductive load switching time



2.2 Test circuits

Figure 12. Inductive load switching and RBSOA test circuit



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3 Package mechanical data

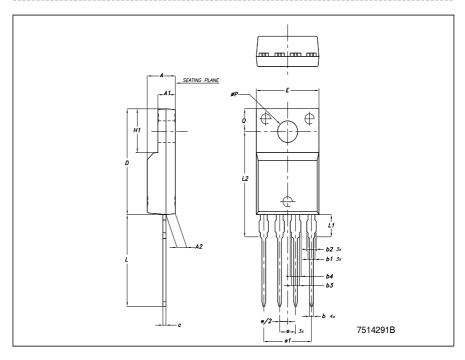
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Obsolete Product(s). Obsolete Product(s)

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TO220FP-4L MECHANICAL DATA

DIM.	mm.				
DIW.	MIN.	TYP	MAX.		
A	4.30	 	4.70		
A1	2.60		3		
A2	1.30	1.50	1.70		
b	0.50		0.70		
b1	1.05				
b2	!		1.3		
b3	1.25				
b4			1.50		
С	0.45	0.50	0.60		
D	¦ 15.50		¦ 15.90		
E	9.80		10.20		
е	2.29	2.54	2.79		
e1	·	7.62	!		
H1	6.30		6.70		
L		13.60			
L1	!	3.30			
L2	15.40		15.80		
Dia P	3		3.40		
Q	3.30	 	3.50		



Obsolete

Revision history STP08IE120F4

4 Revision history

Table 4. Revision history

Date	Revision	Changes
28-Nov-2006	1	Initial release.



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